

## RESET TIMER IC FOR MOBILE EQUIPMENTS

NO.EA-280-120328

### OUTLINE

The R3200x Series are reset timer ICs with two input signals for mobile equipments which require long interval for reset sequence. The long interval prevents unexpected resets caused by accidental key operations. Internally, each of these ICs consist of a delay generator circuit and output driver transistors.

The R3200x Series have two active-low input pins ( $\overline{\text{SR0}}$  and  $\overline{\text{SR1}}$ ) which generate reset signals after output delay time when both input pins are activated at the same time.

R3200x Series has two versions that are different in output delay time settings and output release method.

- R3200x001x : Output delay time selectable (7.5s or 11.25s) by connecting DSR pin to either GND or  $V_{DD}$ .  
The reset signal will be canceled if either of the input pin becomes "H". Until either input pin becomes "H", the reset signal will be continually outputted.
- R3200x002x : Output delay time is fixed at 7.5s. After the reset signal is being output 0.234s, it will be released automatically or if either of the input pin becomes "H", the reset signal will be canceled.

While the reset signals are remaining active or being sent out, the ICs provide ultra-low supply current.

The R3200x Series are available in DFN(PLP)2020-8B and DFN1216-8 packages.

### FEATURES

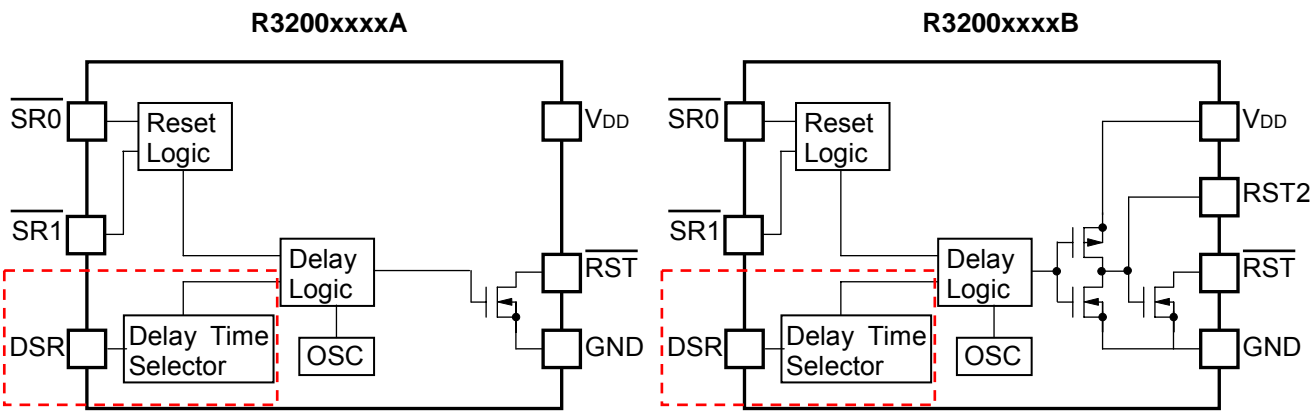
- Supply Current 1 (at standby) ..... Typ. 0.28 $\mu$ A ( $V_{DD}$ =5.5V)
- Supply Current 2 (at active before reset signal output) ..... Typ. 3 $\mu$ A ( $V_{DD}$ =5.5V) \*
- Supply Current 3 (at active after reset signal output) ..... Typ. 0.45 $\mu$ A ( $V_{DD}$ =5.5V)
- Operating Voltage Range ..... 1.65V to 5.5V
- Operating Temperature Range ..... -40 to 85 °C
- Output Delay Time (R3200x001x) ..... Typ. 7.5s or 11.25s Selectable  
(R3200x002x) ..... Typ. 7.5s
- Output Delay Time Accuracy .....  $\pm 20\%$
- Output Release Time (R3200x002x) ..... Typ. 0.234s
- Output Release Time Accuracy (R3200x002x) .....  $\pm 20\%$  (Min. 0.187s, Max. 0.282s)
- Output Types ..... Nch Open Drain and CMOS
- Packages ..... DFN(PLP)2020-8B,  
DFN1216-8

\*) Guaranteed by design engineering.

### APPLICATIONS

- Mobile phone, Smartphone
- E-book, Tablet devices
- Portable Games
- Personal Navigation Devices

BLOCK DIAGRAMS



\*) The red block part exists only in R3200x001x.

SELECTION GUIDE

The combination of output delay time settings and output release method, the package type and the output type for the ICs can be selected at the users' request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R3200Kxxx*-TR	DFN(PLP)2020-8B	5,000 pcs	Yes	Yes
R3200Lxxx*-E2	DFN1216-8	5,000 pcs	Yes	Yes

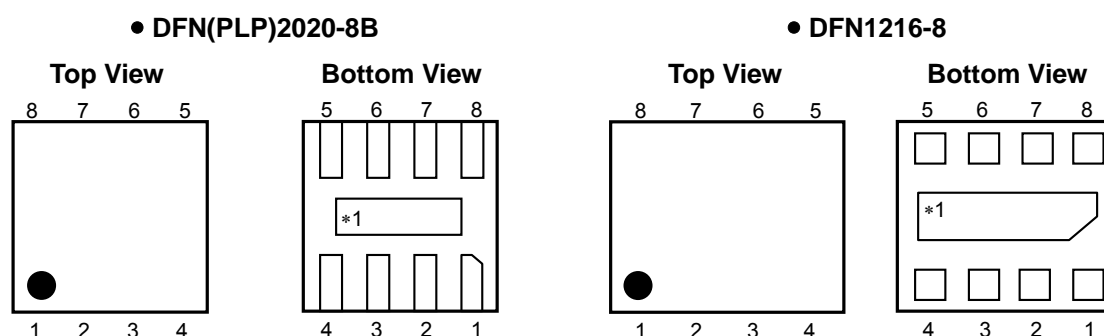
xxx : The combination of output delay time settings and output release method can be designated by serial numbers. (from 001)

(001) The output delay time of the reset signals selectable from 7.5s or 11.25s.  
The reset signal will be canceled if either of the input pin becomes "H". Until either input pin becomes "H", the reset signal will be continually outputted.

(002) The output delay time of the reset signals is fixed at 7.5s. After reset signal is being output 0.234s, it will be released automatically or if either of the input pin becomes "H", the reset signal will be canceled.

\* : Designation of Output Type  
(A) Nch Open Drain  
(B) Nch Open Drain and CMOS

## PIN CONFIGURATIONS



\*) Tab is GND level. (They are connected to the reverse side of this IC.)

The tab is better to be connected to the GND, but leaving it open is also acceptable

## PIN DESCRIPTIONS

### • DFN(PLP)2020-8B, DFN1216-8

Pin No.	Symbol	Description
1	NC	No Connection (Only for A version)
	RST2	CMOS Output Pin, "H" Active (Only for B version)
2	GND	Ground Pin
3	$\overline{\text{SR1}}$	2nd Reset Input Pin, ("L" Active) *1
4	$\overline{\text{RST}}$	Nch Open Drain Output Pin, ("L" Active) *2
5	DSR	Output Delay Time Selection Pin (R3200x001x) (GND: 7.5s, $V_{\text{DD}}$ : 11.25s) *3
	TEST2	Test Pin *4 (R3200x002x)
6	TEST	Test Pin *4
7	$\overline{\text{SR0}}$	1st Reset Input Pin, ("L" Active) *1
8	$V_{\text{DD}}$	Power Supply Input Pin

\*1) In the case of using one "L" active input signal pin, either  $\overline{\text{SR0}}$  or  $\overline{\text{SR1}}$  must be connected to GND.

\*2) In the case of using B version without  $\overline{\text{RST}}$ ,  $\overline{\text{RST}}$  must be connected to GND or left open.

\*3) DSR pin must be connected to either GND or  $V_{\text{DD}}$ .

\*4) TEST must be connected to GND.

## ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V <sub>DD</sub>	Supply Voltage	GND-0.3 to 6	V
V <sub>SR0</sub>	Input Voltage (1st Reset input pin)	GND-0.3 to 6	V
V <sub>SR1</sub>	Input Voltage (2nd Reset input pin)	GND-0.3 to 6	V
V <sub>RST</sub>	Output Voltage (1st Reset output pin)	GND-0.3 to 6	V
V <sub>RST2</sub>	Output Voltage (2nd Reset output pin)	GND-0.3 to V <sub>DD</sub> +0.3	V
V <sub>DSR</sub>	Input Voltage (Output Delay Time Selection Pin) (only R3200x001x)	GND-0.3 to 6	V
I <sub>OUT</sub>	Output Current	20	mA
P <sub>D</sub>	Power Dissipation (DFN(PLP)2020-8B)*	880	mW
	Power Dissipation (DFN1216-8)*	625	
T <sub>opt</sub>	Operating Temperature Range	−40 to 85	°C
T <sub>stg</sub>	Storage Temperature Range	−55 to 125	°C

\*) For Power Dissipation, please refer to PACKAGE INFORMATION.

### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

## ELECTRICAL CHARACTERISTICS

### • R3200x001x

The specification in    is checked and guaranteed by design engineering at  $-40^{\circ}\text{C} \leq T_{\text{opt}} \leq 85^{\circ}\text{C}$ .

$T_{\text{opt}}=25^{\circ}\text{C}$

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
$V_{\text{DD}}$	Operating Voltage		<span style="border: 1px solid black; padding: 0 2px;">1.65</span>		<span style="border: 1px solid black; padding: 0 2px;">5.5</span>	V
$I_{\text{SS1}}$	Supply Current1	$V_{\text{DD}}=5.5\text{V}$ , at standby		0.28	<span style="border: 1px solid black; padding: 0 2px;">1.35</span>	$\mu\text{A}$
$I_{\text{SS2}}$	Supply Current2	$V_{\text{DD}}=5.5\text{V}$ , at active before reset signal output		3.0	<span style="border: 1px solid black; padding: 0 2px;">6.5</span>	$\mu\text{A}$
$I_{\text{SS3}}$	Supply Current3	$V_{\text{DD}}=5.5\text{V}$ , at active after reset signal output		0.45	<span style="border: 1px solid black; padding: 0 2px;">1.7</span>	$\mu\text{A}$
$V_{\text{OL}}$	"L" Output Voltage	$V_{\text{DD}} \geq 4.5\text{V}$ $I_{\text{OL}}=8\text{mA}$			<span style="border: 1px solid black; padding: 0 2px;">0.3</span>	V
		$V_{\text{DD}} \geq 3.3\text{V}$ $I_{\text{OL}}=5\text{mA}$				
		$V_{\text{DD}} \geq 1.65\text{V}$ $I_{\text{OL}}=3\text{mA}$				
$V_{\text{OH}}$	"H" Output Voltage (Only for B version)	$V_{\text{DD}} \geq 4.5\text{V}$ $I_{\text{OH}}=5\text{mA}$				V
		$V_{\text{DD}} \geq 3.3\text{V}$ $I_{\text{OH}}=2.5\text{mA}$	$V_{\text{DD}} \times 0.85$			
		$V_{\text{DD}} \geq 1.65\text{V}$ $I_{\text{OH}}=0.8\text{mA}$				
$I_{\text{LEAKI}}$	$\overline{\text{SR}}0$ , $\overline{\text{SR}}1$ Input Leakage Current	$V_{\text{DD}} = 5.5\text{V}$			<span style="border: 1px solid black; padding: 0 2px;">0.1</span>	$\mu\text{A}$
$I_{\text{LEAKO}}$	Output Leakage Current	$V_{\text{DD}} = 5.5\text{V}$			<span style="border: 1px solid black; padding: 0 2px;">0.1</span>	$\mu\text{A}$
$t_{\text{DELAY}}$	Output Delay Time	DSR=GND	<span style="border: 1px solid black; padding: 0 2px;">6</span>	7.5	<span style="border: 1px solid black; padding: 0 2px;">9</span>	s
		DSR= $V_{\text{DD}}$	<span style="border: 1px solid black; padding: 0 2px;">9</span>	11.25	<span style="border: 1px solid black; padding: 0 2px;">13.5</span>	s
$V_{\text{IL}}$	$\overline{\text{SR}}0$ , $\overline{\text{SR}}1$ "L" Input Voltage				<span style="border: 1px solid black; padding: 0 2px;">0.3</span>	V
$V_{\text{IH}}$	$\overline{\text{SR}}0$ , $\overline{\text{SR}}1$ "H" Input Voltage		<span style="border: 1px solid black; padding: 0 2px;">0.85</span>			V

All of units are tested and specified under load conditions such that  $T_j \approx T_{\text{opt}} = 25^{\circ}\text{C}$  except for Supply Current2.

#### RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

## R3200x

### • R3200x002x

The specification in ☐ is checked and guaranteed by design engineering at  $-40^{\circ}\text{C} \leq T_{\text{opt}} \leq 85^{\circ}\text{C}$ .

$T_{\text{opt}}=25^{\circ}\text{C}$

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
$V_{\text{DD}}$	Operating Voltage		1.65		5.5	V
$I_{\text{SS1}}$	Supply Current1	$V_{\text{DD}}=5.5\text{V}$ , at standby		0.28	1.35	$\mu\text{A}$
$I_{\text{SS2}}$	Supply Current2	$V_{\text{DD}}=5.5\text{V}$ , at active before reset signal output		3.0	6.5	$\mu\text{A}$
$I_{\text{SS3}}$	Supply Current3	$V_{\text{DD}}=5.5\text{V}$ , at active after reset signal output		0.45	1.7	$\mu\text{A}$
$V_{\text{OL}}$	"L" Output Voltage	$V_{\text{DD}} \geq 4.5\text{V}$ $I_{\text{OL}}=8\text{mA}$			0.3	V
		$V_{\text{DD}} \geq 3.3\text{V}$ $I_{\text{OL}}=5\text{mA}$				
		$V_{\text{DD}} \geq 1.65\text{V}$ $I_{\text{OL}}=3\text{mA}$				
$V_{\text{OH}}$	"H" Output Voltage (Only for B version)	$V_{\text{DD}} \geq 4.5\text{V}$ $I_{\text{OH}}=5\text{mA}$	$V_{\text{DD}} \times 0.85$			V
		$V_{\text{DD}} \geq 3.3\text{V}$ $I_{\text{OH}}=2.5\text{mA}$				
		$V_{\text{DD}} \geq 1.65\text{V}$ $I_{\text{OH}}=0.8\text{mA}$				
$I_{\text{LEAKI}}$	$\overline{\text{SR0}}$ , $\overline{\text{SR1}}$ Input Leakage Current	$V_{\text{DD}} = 5.5\text{V}$			0.1	$\mu\text{A}$
$I_{\text{LEAKO}}$	Output Leakage Current	$V_{\text{DD}} = 5.5\text{V}$			0.1	$\mu\text{A}$
$t_{\text{DELAY}}$	Output Delay Time		6	7.5	9	s
$t_{\text{REC}}$	Output Release Time		0.187	0.234	0.282	s
$V_{\text{IL}}$	$\overline{\text{SR0}}$ , $\overline{\text{SR1}}$ "L" Input Voltage				0.3	V
$V_{\text{IH}}$	$\overline{\text{SR0}}$ , $\overline{\text{SR1}}$ "H" Input Voltage		0.85			V

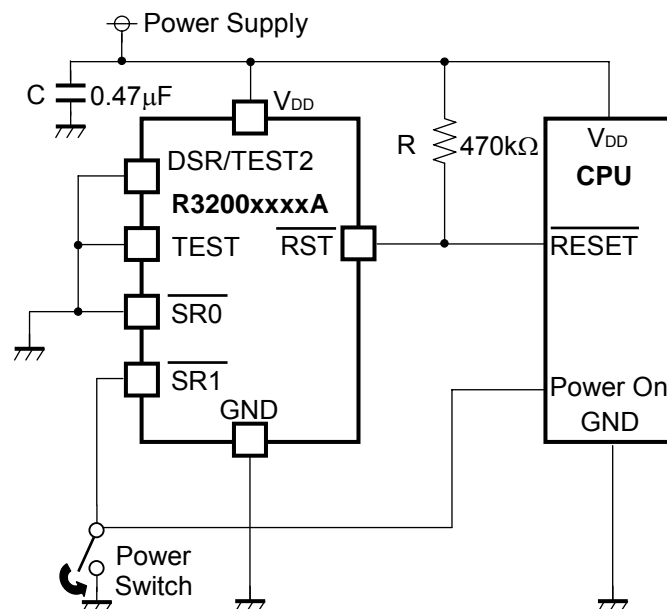
All of units are tested and specified under load conditions such that  $T_j \approx T_{\text{opt}}=25^{\circ}\text{C}$  except for Supply Current2.

#### RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

## TYPICAL APPLICATIONS

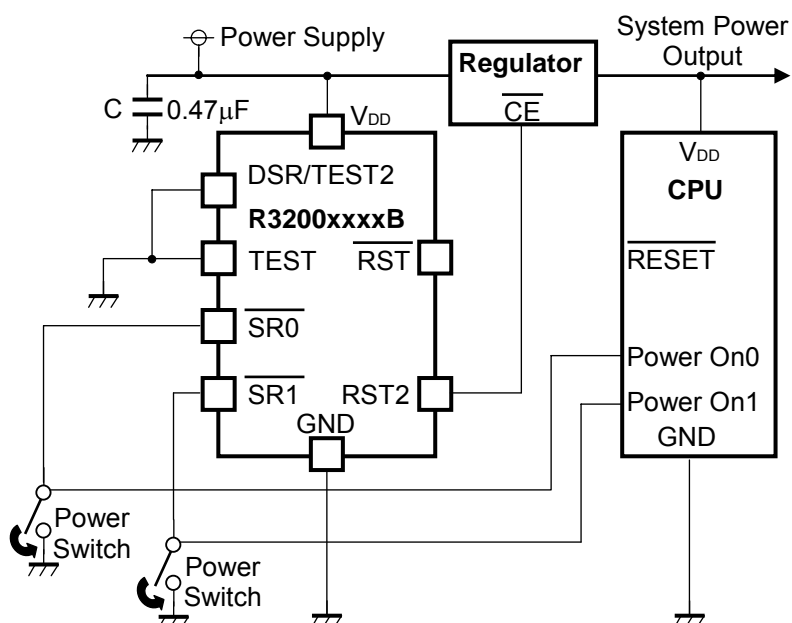
### • R3200x001A



$\overline{\text{RST}}$  pin should be pulled up with a resistor. The recommended value for the resistor is 470k $\Omega$ .

In the case of using one active-low input signal-pin, either  $\overline{\text{SR0}}$  or  $\overline{\text{SR1}}$  pin should be connected to GND.

### • R3200x001B

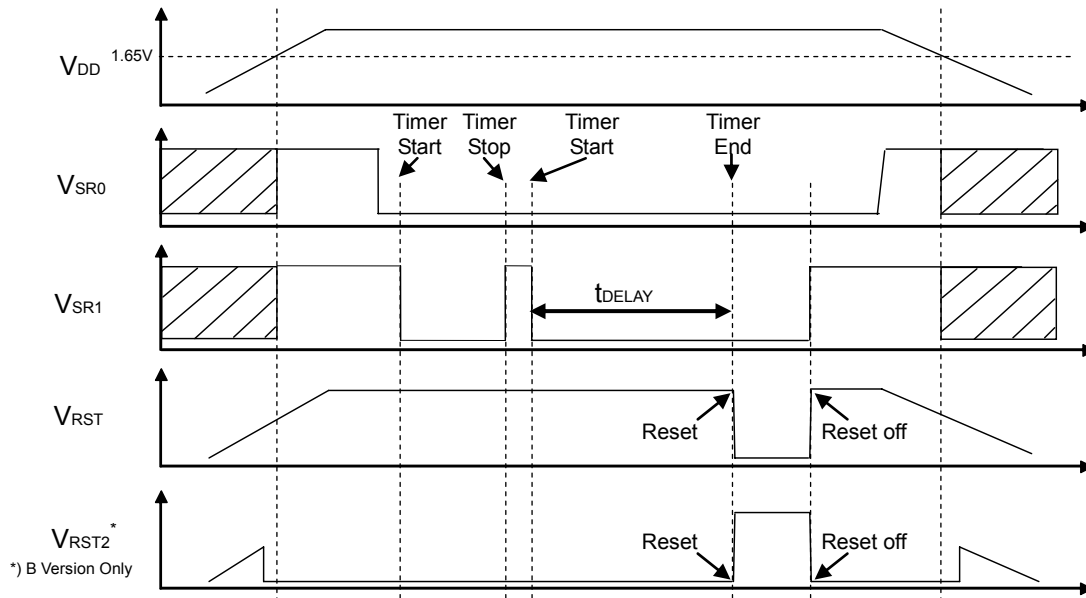


(External Components)

C: Ceramic 0.47 $\mu\text{F}$  Ex. Murata GRM155B30J474KE18

## TIMING CHART

### • R3200x001x



## OPERATION

### • R3200x001x

When both  $\overline{\text{SR0}}$  and  $\overline{\text{SR1}}$  voltages become "L", the timer operation will start. After the output delay time ( $t_{\text{DELAY}}$ ), the reset signal will be outputted. If either  $\overline{\text{SR0}}$  or  $\overline{\text{SR1}}$  voltage becomes "H", the timer operation will be stopped.

During the output delay time, if either  $\overline{\text{SR0}}$  or  $\overline{\text{SR1}}$  becomes "H", the timer operation will stop. If both  $\overline{\text{SR0}}$  and  $\overline{\text{SR1}}$  voltages become "L" again, after the output delay time ( $t_{\text{DELAY}}$ ) the reset signal will be outputted.

While the reset signal is being outputted, either  $\overline{\text{SR0}}$  or  $\overline{\text{SR1}}$  voltage becomes "H", the reset signal will be canceled. Until either  $\overline{\text{SR0}}$  or  $\overline{\text{SR1}}$  voltage becomes "H", the reset signal will be continually outputted.

## OUTPUT DELAY TIME SWITCHING

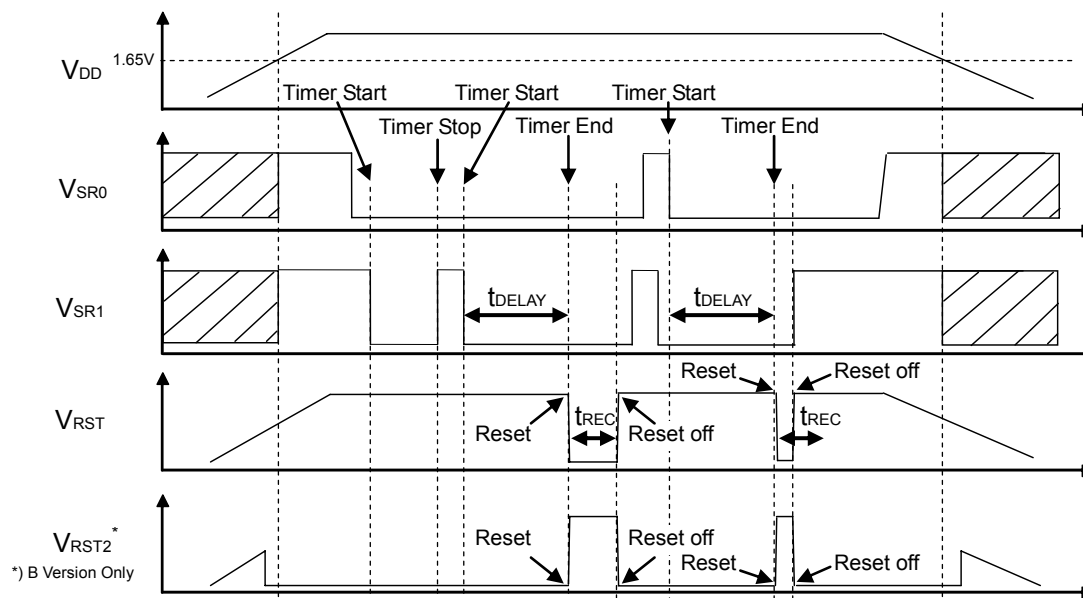
### • R3200x001x

The output delay time can be selected 7.5s (Typ.) or 11.25s (Typ.) by connecting DSR pin to either GND or to V<sub>DD</sub>. However, if DSR is switched during the operations, the output would become unstable and may cause false operations. Switching DSR must be done during power-off. Also, DSR must be connected to either GND or V<sub>DD</sub> because if DSR pin is not connected to either GND or V<sub>DD</sub>, the output would become unstable and may cause false operations.



## TIMING CHART

### • R3200x002x



## OPERATION

### • R3200x002x

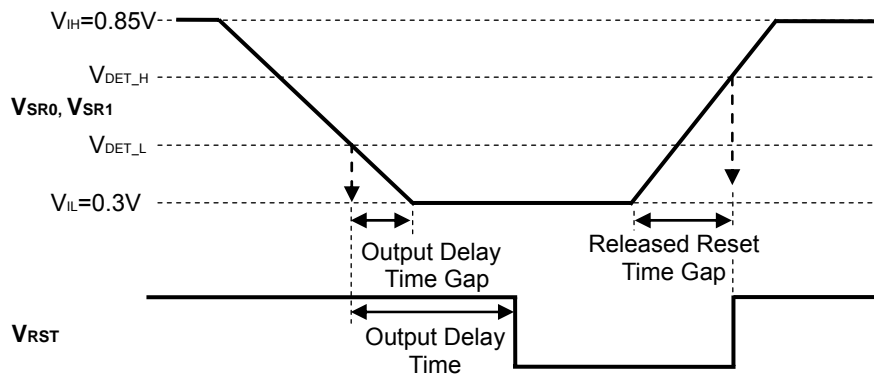
When both  $\overline{SR0}$  and  $\overline{SR1}$  voltages become "L", the timer operation will start. After the output delay time ( $t_{DELAY}$ ), the reset signal will be outputted. If either  $\overline{SR0}$  or  $\overline{SR1}$  voltage becomes "H", the timer operation will be stopped..

During the output delay time, if either  $\overline{SR0}$  or  $\overline{SR1}$  becomes "H", the timer operation will stop. If both  $\overline{SR0}$  and  $\overline{SR1}$  voltages become "L" again, after the output delay time ( $t_{DELAY}$ ) the reset signal will be outputted.

After reset signal is being sent 0.234s, it will be released automatically, or if either  $\overline{SR0}$  or  $\overline{SR1}$  becomes "H", the reset signal will be canceled.

## OUTPUT DELAY TIME GAP

The threshold voltages of  $\overline{SR0}$  and  $\overline{SR1}$  are between  $V_{IL}$  and  $V_{IH}$ . Therefore, if the rising or falling slew rate is very slow, the timer will start at the point of crossing the threshold voltage and may cause errors in the output delay time ( $t_{DELAY}$ ) and the released reset time.

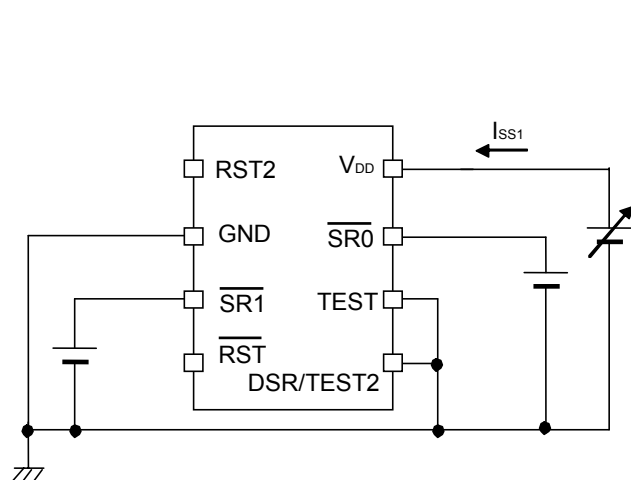


Example: Relation between the Rising and Falling Slew Rate and the Time Gap

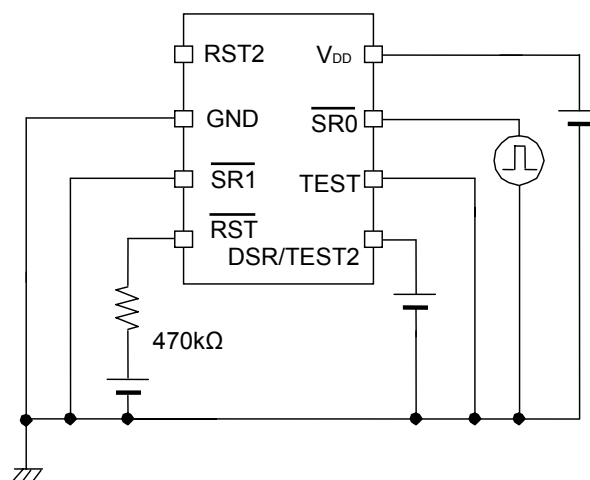
## PRECAUTIONS: $V_{DD}$ Start-up during Low Input

When starting up  $V_{DD}$  at slow slew rate of  $0.001V/\mu s$  or less with the low  $\overline{SR0}$  and  $\overline{SR1}$  voltages, the ICs may start the operation at lower than the minimum operating voltage, thus the output delay time may exceed the guaranteed time.

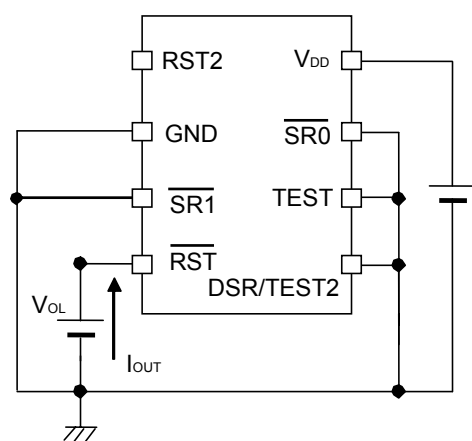
## TEST CIRCUITS



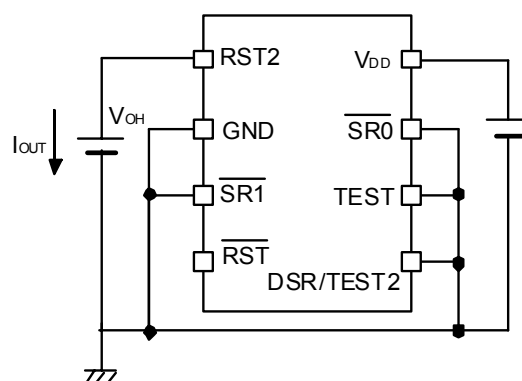
Supply Current Test Circuit



Output Delay Time Test Circuit



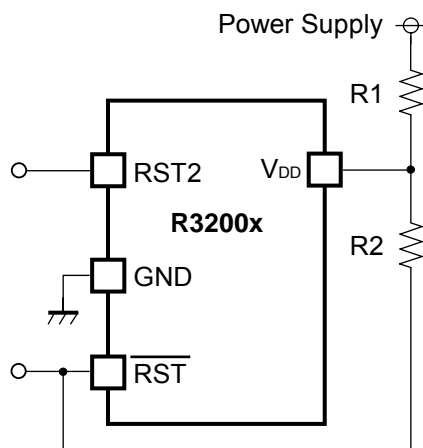
NMOS Driver Output Voltage Test Circuit



CMOS Driver Output Voltage Test Circuit  
(B version only)

## PRECAUTIONS: Circuit Configuration

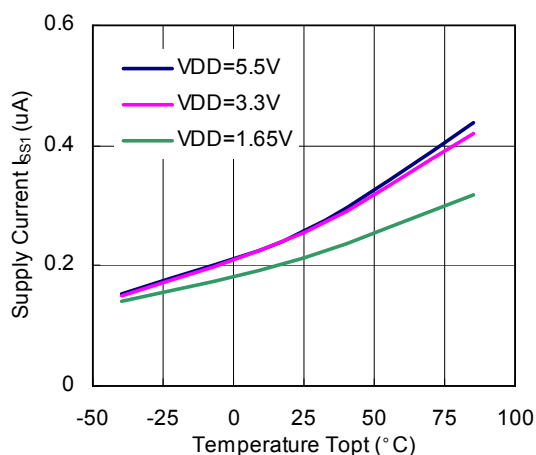
In the case of applying the following circuit configuration (Fig.A) to the R3200x Series, if the R1 value is high, the ICs own supply current may cause significant voltage drop to  $V_{DD}$  pin, and  $V_{DD}$  voltage may fall below the minimum operating voltage.



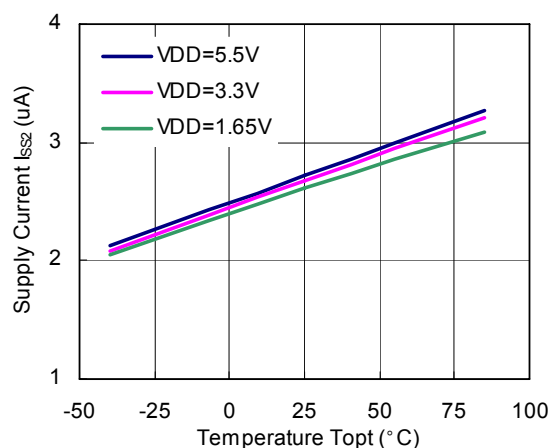
**Fig. A**

## TYPICAL CHARACTERISTICS

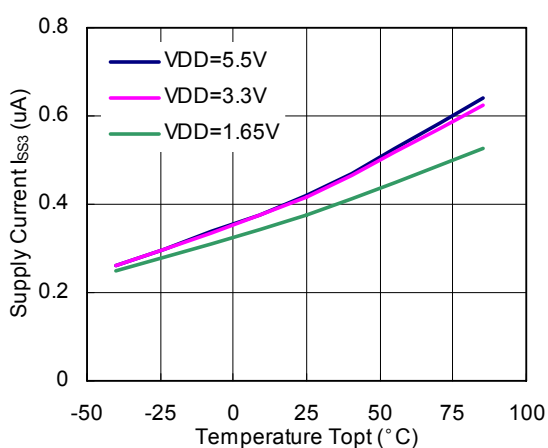
1) Supply Current 1 vs. Temperature  
R3200x (at standby)



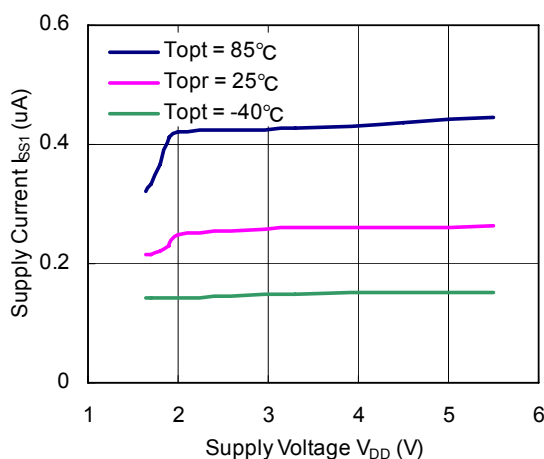
2) Supply Current 2 vs. Temperature  
R3200x (before the reset signal output)



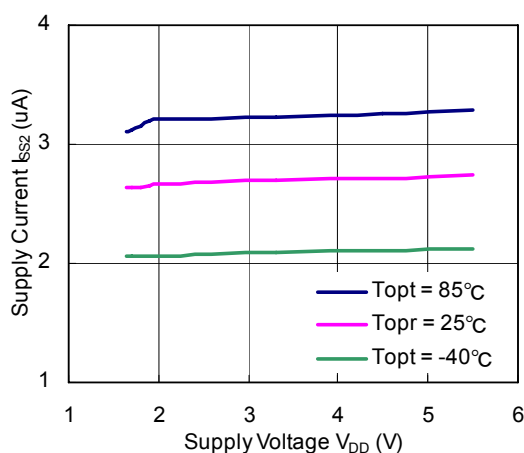
3) Supply Current 3 vs. Temperature  
R3200x (after the reset signal output)



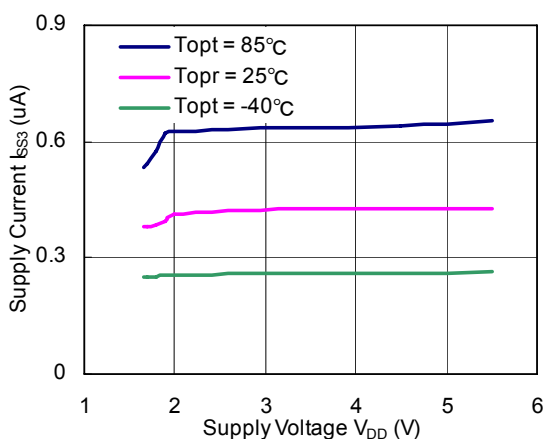
4) Supply Current 1 vs. Supply Voltage  
R3200x (at standby)



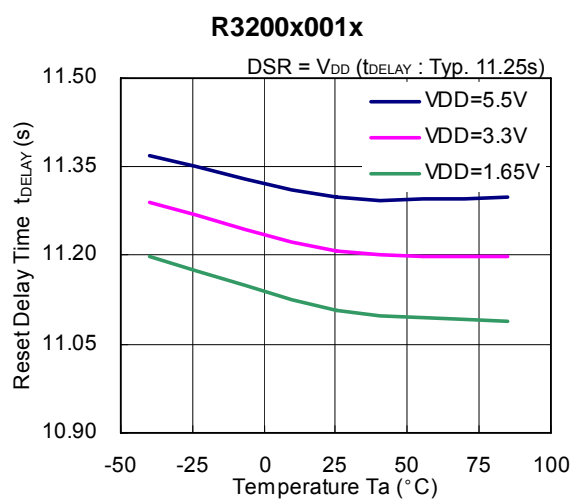
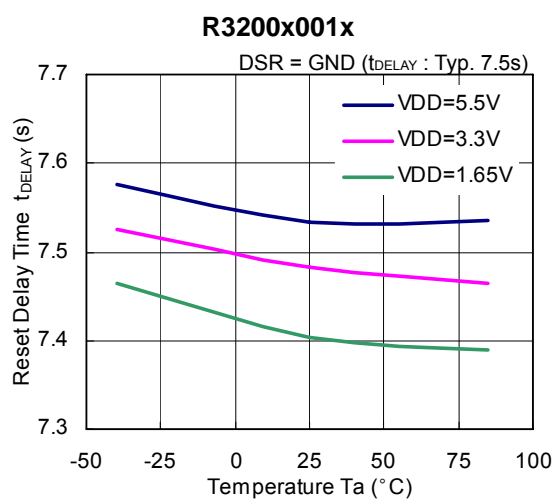
5) Supply Current 2 vs. Supply Voltage  
R3200x (before the reset signal output)



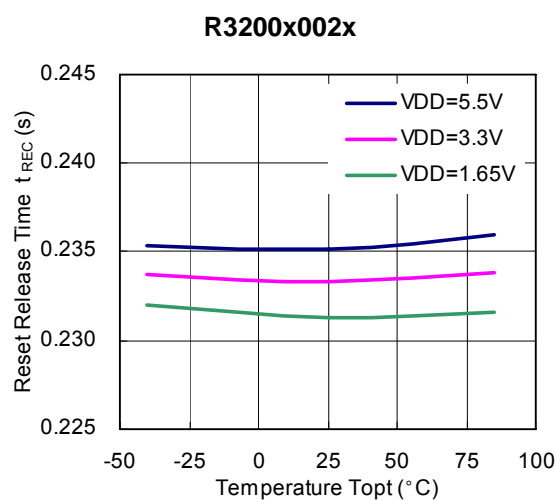
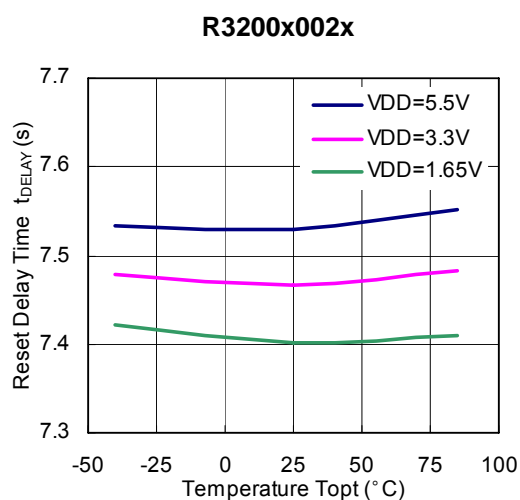
6) Supply Current 2 vs. Supply Voltage  
R3200x (after the reset signal output)



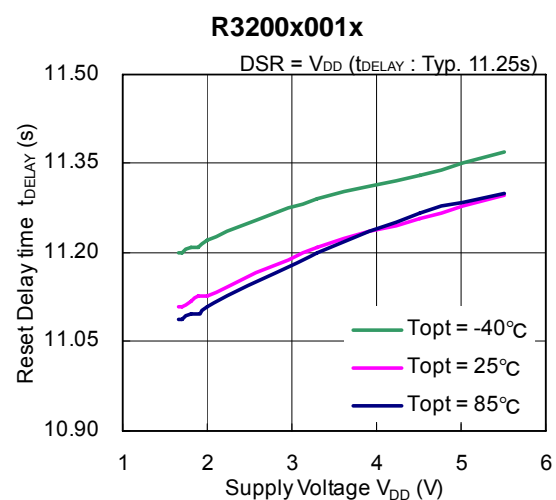
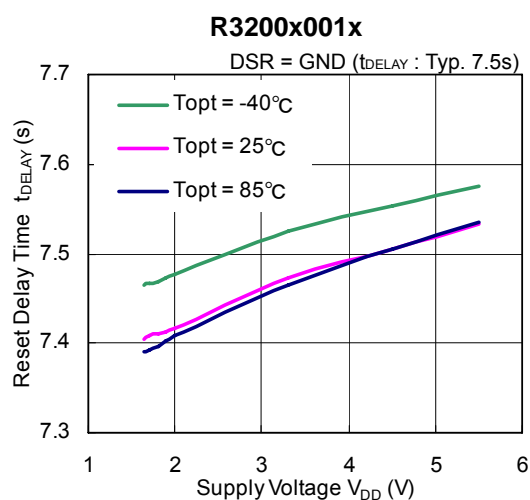
## 7) Output Delay Time vs. Temperature



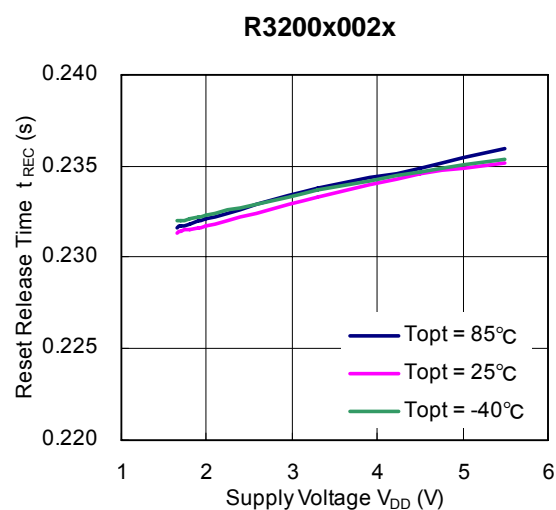
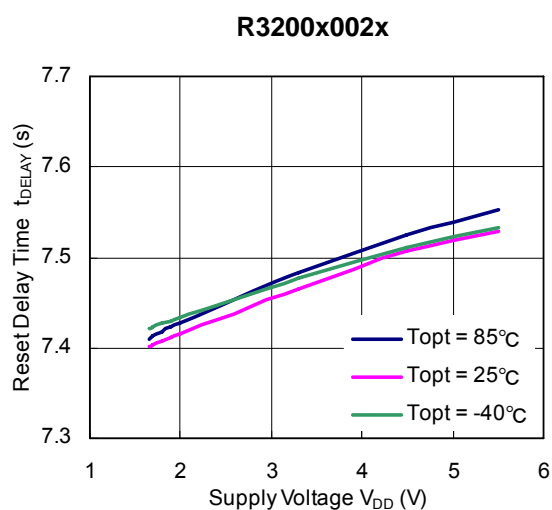
## 8) Output Release Time vs. Temperature



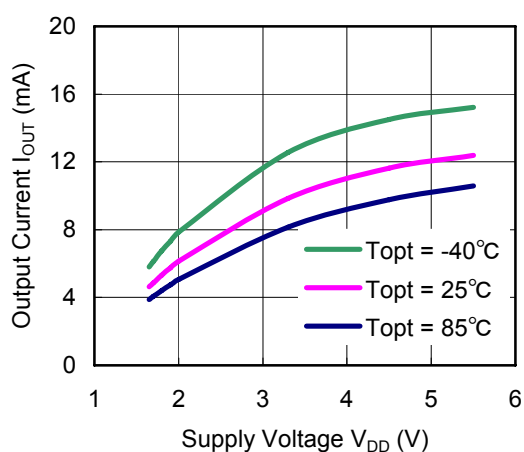
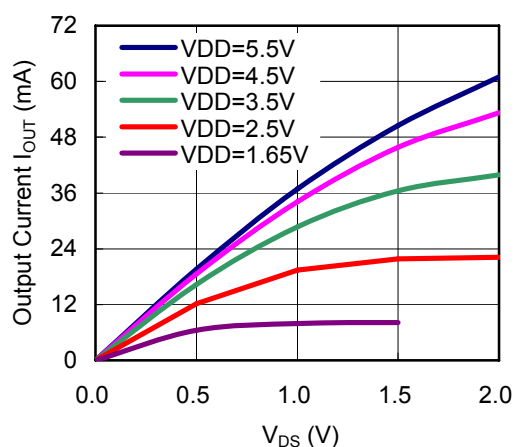
## 9) Output Delay Time vs. Supply Voltage



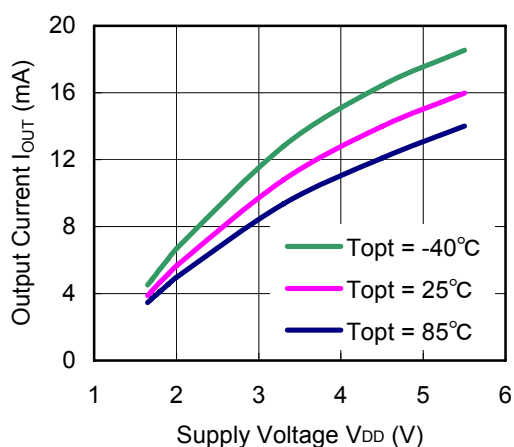
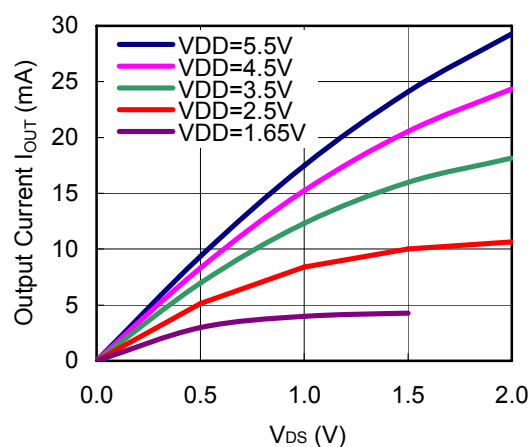
## 10) Output Release Time vs. Supply Voltage



## 11) Nch Driver Output Current vs. Supply Voltage

 $V_{\text{DS}}=0.3\text{V}$ 12) Nch Driver Output Current vs.  $V_{\text{DS}}$ 

## 13) Pch Driver Output Current vs. Supply Voltage

 $V_{\text{DS}}=0.9\text{V}$ 14) Pch Driver Output Current vs.  $V_{\text{DS}}$ 



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7. Anti-radiation design is not implemented in the products described in this document.
8. Please contact Ricoh sales representatives should you have any questions or comments concerning the products or the technical information.

## RICOH COMPANY., LTD. Electronic Devices Company



■ Ricoh presented with the Japan Management Quality Award for 1999.  
Ricoch continually strives to promote customer satisfaction, and shares the achievements of its management quality improvement program with people and society.



■ Ricoh awarded ISO 14001 certification.

The Ricoh Group was awarded ISO 14001 certification, which is an international standard for environmental management systems, at both its domestic and overseas production facilities. Our current aim is to obtain ISO 14001 certification for all of our business offices.

<http://www.ricoh.com/LSI/>

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Ricoh completed the organization of the Lead-free production for all of our products. After Apr. 1, 2006, we will ship out the lead free products only. Thus, all products that will be shipped from now on comply with RoHS Directive.